+357 96 030922
info@marketpublishers.com

Global MEMS Pressure Sensor Dies and ICs Market 2026 by Manufacturers, Regions, Type and Application, Forecast to 2032

https://marketpublishers.com/r/GEFF76077AA8EN.html
Date: September 2026
Pages: 223
Price: US$ 3,480.00 (Single User License)
ID: GEFF76077AA8EN

Abstracts

According to our (Global Info Research) latest study, the global MEMS Pressure Sensor Dies and ICs market size was valued at US$ 2747 million in 2025 and is forecast to a readjusted size of US$ 4037 million by 2032 with a CAGR of 5.6% during review period.

MEMS Pressure Sensor Dies and ICs are chip-level sensing devices that convert gas or liquid pressure into electrical signals through micromachined pressure-sensitive structures formed on silicon, silicon-on-insulator, bonded-glass or comparable semiconductor substrates. The research scope covers bare sensor dies, pressure-sensing elements, uncompensated packaged devices, analog compensated sensor ICs, digital pressure sensor ICs and application-specific integrated pressure devices. Main sensing principles include piezoresistive, capacitive and resonant conversion, while typical integration functions comprise temperature compensation, signal amplification, non-linearity correction, analog-to-digital conversion, calibration memory and digital communication interfaces. Key product specifications include pressure reference, full-scale range, accuracy, sensitivity, noise, temperature drift, long-term stability, proof pressure, media compatibility, power consumption and package dimensions. MEMS Pressure Sensor Dies and ICs perform absolute, gauge, sealed-gauge or differential pressure measurement across automotive pressure management, barometric altitude sensing, medical pressure monitoring, industrial process control, HVAC airflow measurement and high-reliability dynamic pressure applications

Key Findings

Automotive applications represent approximately 46% of market revenue and

+357 96 030922
info@marketpublishers.com

remain the largest value segment

Piezoresistive technology accounts for roughly 55% to 60% of demand and remains the dominant sensing principle

The confirmed core supplier base contains 31 parent companies after subsidiary and brand consolidation

Europe North America and Japan lead high value supply while China records the fastest supplier expansion

Market Trends

The development of MEMS Pressure Sensor Dies and ICs is shifting from standalone pressure-sensitive elements toward smaller, lower-power and more highly integrated devices combining the MEMS structure, signal-conditioning ASIC, calibration memory and digital interface. In high-volume barometric applications, product differentiation increasingly depends on noise, relative accuracy, power consumption, package size and resistance to environmental disturbance rather than measurement range alone. Automotive products are adding embedded diagnostics, dedicated communication interfaces and media-compatible packaging to support pressure monitoring in powertrain, braking, thermal-management and battery systems. Medical and industrial products are moving toward lower differential-pressure ranges, improved batch consistency, reduced long-term drift and application-specific packaging. Bare dies remain important where customers require proprietary fluid interfaces or highly customized packages, while compensated digital ICs continue gaining adoption in standardized electronic systems. Product design is therefore becoming more closely integrated with wafer-level calibration, package-stress control, embedded processing and end-application qualification. Current commercial products demonstrate the industry’s emphasis on ultra-low power, low noise, digital interfaces, integrated MEMS-and-ASIC architectures and new battery-pressure monitoring functions.

Market Dynamics

Drivers

Demand is supported by the rising number of pressure-measurement points in vehicles,

+357 96 030922
info@marketpublishers.com

industrial equipment, medical devices and connected electronic products. Automotive electrification is extending pressure sensing beyond conventional manifold and barometric functions into battery-pack monitoring, thermal management, braking and cabin systems, where reliability and diagnostic capability increase semiconductor value per vehicle. Energy-efficiency requirements in HVAC systems are also encouraging more precise differential-pressure and airflow control, while respiratory equipment, electronic blood-pressure monitors and minimally invasive medical devices require compact devices capable of measuring very low pressures. Improvements in MEMS process control, digital compensation and wafer-level testing allow suppliers to deliver better accuracy and stability without proportionally increasing package size or system complexity. These demand and technology factors support unit expansion across both established applications and newly instrumented systems.

Restraints

Market expansion is constrained by persistent price pressure in high-volume consumer products, long qualification cycles in automotive and medical applications, and the high cost of achieving stable performance across temperature, pressure and media conditions. Pressure devices are particularly sensitive to package stress, contamination, protective materials and calibration errors, meaning that nominally similar MEMS dies can deliver materially different field performance after packaging. Suppliers must also manage capital-intensive wafer processing, precision testing and device-by-device compensation while serving applications with widely different volumes and average selling prices. In selected industrial systems, ceramic, thin-film, strain-gauge and other pressure technologies remain practical alternatives, especially where extreme pressure, chemical exposure or low production volume makes a silicon MEMS solution less economical.

Opportunities

The strongest opportunities are emerging in electric-vehicle safety and thermal systems, ultra-low differential-pressure measurement, miniature medical sensing, intelligent HVAC control and rugged environmental monitoring. Battery pressure detection is developing into a new automotive use case because rapid internal pressure changes can provide an additional indication of abnormal battery conditions. Low-power barometric devices also have room to expand in wearables, indoor navigation, drones and distributed connected equipment as accuracy improves and standby consumption declines. In medical and industrial applications, suppliers can create greater value

+357 96 030922
info@marketpublishers.com

through application-specific dies, media-compatible structures, isolated packages and integrated digital compensation rather than competing only on basic sensing-element cost. Regional supply-chain localization creates an additional opening for manufacturers that can demonstrate stable wafer yields, qualification records and long-term product availability.

Challenges

The principal long-term challenge is converting laboratory-level sensitivity and accuracy into repeatable high-volume performance. New suppliers must prove wafer uniformity, calibration capability, packaging reliability, temperature stability and customer-specific qualification over extended product life cycles. The industry also lacks a single standardized product architecture because pressure reference, range, port design, media exposure, output format and protection requirements differ substantially between applications. This fragmentation increases development expense and limits the reuse of one platform across all markets. At the same time, leading semiconductor and sensor groups benefit from established customer platforms, manufacturing scale and broad application support, making entry into automotive safety, medical and high-reliability industrial programs particularly difficult. Consolidation may further raise the commercial and technical threshold for smaller independent suppliers.

Industry Chain Analysis

The upstream industry chain comprises semiconductor-grade silicon and SOI wafers, glass and bonding materials, photoresists, specialty gases, piezoresistive or electrode materials, ASIC intellectual property, wafer fabrication equipment, packaging materials and calibration equipment. MEMS foundries and semiconductor manufacturing platforms may provide lithography, etching, implantation, bonding and metallization services, but value creation at the product-company level depends on ownership of the sensor structure, process design, compensation algorithm and application specification. Pressure-sensor manufacturing is more application-sensitive than many other MEMS categories because diaphragm dimensions, reference cavities, protective gels, media exposure and package stress directly affect accuracy and reliability.

The midstream process covers MEMS design, wafer fabrication, wafer bonding, sensor-die testing, ASIC design, die attachment, packaging, calibration, compensation and final reliability testing. Bare dies move directly to specialized sensor and medical-device

+357 96 030922
info@marketpublishers.com

manufacturers, while integrated ICs are supplied to module producers, electronic-system manufacturers and automotive component platforms. The highest value is generally created through repeatable wafer yield, low-drift sensor structures, high-throughput calibration, robust packaging and application certification rather than through raw wafer processing alone. Consumer products rely on scale and cost efficiency, whereas automotive, medical, industrial and aerospace products derive a larger proportion of value from qualification, traceability, media compatibility and long-term supply assurance. Official product portfolios show that commercial offerings range from micromachined bare dies to devices combining a MEMS die, ASIC and passive components within an isolated package.

Segment Insights

By product form, the market consists of bare sensor dies, uncompensated packaged elements, analog compensated devices, digital pressure sensor ICs and application-specific integrated pressure devices. Digital ICs are prominent in high-volume barometric and standardized electronic applications because they simplify system design through embedded calibration and serial communication. Bare dies and uncompensated elements retain strategic importance in medical, industrial and custom sensor assemblies where customers control the pressure port, protective medium and package design. Application-specific ICs generally command higher value because they incorporate diagnostics, dedicated interfaces or protection features developed for defined operating conditions.

By sensing principle, piezoresistive products account for an estimated 55% to 60% of market demand and remain the largest technology category because they support broad pressure ranges, established manufacturing processes and extensive automotive, medical and industrial use. Capacitive devices represent approximately 28% to 33%, with particular strength in low-power barometric, low-pressure and high-sensitivity applications. Resonant devices account for a smaller, high-precision segment concentrated in industrial, meteorological and aerospace measurement. By pressure reference, absolute devices dominate barometric and manifold functions, differential products are central to airflow and filter monitoring, and gauge or sealed-gauge devices address fluid and process-pressure measurement. The most commercially relevant cross-segment opportunities occur where digital integration, low-pressure resolution, media compatibility and compact packaging intersect.

+357 96 030922
info@marketpublishers.com

Downstream Market Opportunities

Automotive applications contribute approximately 46% of market revenue and remain the primary value pool because one vehicle may require multiple pressure functions with demanding qualification and reliability standards. Industrial and HVAC applications represent slightly more than one-fifth of demand and offer opportunities in airflow control, filter monitoring, process automation and energy-efficient equipment. Consumer electronics account for roughly one-sixth of the market, supported by large unit shipments but exposed to sustained price erosion. Medical applications contribute approximately one-tenth and provide attractive specialist opportunities in respiratory care, electronic blood-pressure measurement, catheters, dialysis, infusion and microfluidic systems. Aerospace, defense and other applications form a smaller share but support higher-value products where dynamic response, temperature stability and long service life are critical. Future growth is expected to depend more on additional sensing functions and higher device content per system than on simple replacement of existing pressure components.

Regional Insights

Europe, North America and Japan remain the principal high-value supply regions. Europe has a strong concentration of automotive semiconductor groups, integrated digital pressure IC suppliers and specialist industrial sensor companies. North America is particularly competitive in medical pressure dies, board-level industrial products, aerospace sensing and specialized low-pressure devices. Japan maintains established capabilities in capacitive pressure elements, compact barometric ICs and reliable industrial and medical products. These regions benefit from mature MEMS processes, qualification experience, global customer relationships and established packaging and calibration infrastructure.

China is the fastest-expanding supplier region and has developed a broader base of MEMS design companies, sensor manufacturers and integrated device suppliers. Its opportunity is shifting from packaging imported dies toward proprietary sensor structures, ASIC integration, localized wafer processing and automotive qualification. Taiwan remains important in MEMS foundry, ODM and customized wafer production, while Southeast Asia plays a major role in packaging, testing and multinational manufacturing operations. South Korea, India and the Middle East have more limited publicly visible independent supplier bases, although they retain potential in captive manufacturing, specialized design and selected defense or industrial applications.

+357 96 030922
info@marketpublishers.com

Regional competition will increasingly be determined by verified production yield, supply continuity and qualification capability rather than the number of announced projects.

Competitive Landscape Analysis

The competitive landscape is moderately concentrated at the high-volume and high-reliability end but remains fragmented across specialist product niches. The confirmed Core Formal List contains 31 parent companies after subsidiaries, acquired operations and product brands are consolidated. Large semiconductor and diversified sensor groups compete through vertically integrated MEMS processes, ASIC capability, calibration scale, application qualification and global channels. Mid-sized specialists differentiate through bare dies, ultra-low differential-pressure products, media-compatible structures, resonant sensing or high-temperature and dynamic-pressure performance. Chinese suppliers are becoming more visible in consumer, automotive and industrial products, although their positions vary significantly in wafer ownership, production scale and qualification maturity. Strategic consolidation is also reshaping the supplier structure. STMicroelectronics completed the acquisition of NXP’s MEMS sensor business on February 2, 2026, expanding its position across automotive and industrial sensing and requiring the former NXP operation to be consolidated under ST in current supplier analysis. Competitive advantage is therefore moving beyond nominal die sensitivity toward a broader combination of process yield, embedded electronics, package engineering, field reliability, customer qualification and long-term product support.

Report Scope

This report is a detailed and comprehensive analysis for global MEMS Pressure Sensor Dies and ICs market. Both quantitative and qualitative analyses are presented by manufacturers, by region & country, by Type and by Application. As the market is constantly changing, this report explores the competition, supply and demand trends, as well as key factors that contribute to its changing demands across many markets. Company profiles and product examples of selected competitors, along with market share estimates of some of the selected leaders for the year 2025, are provided.

Key Features:

+357 96 030922
info@marketpublishers.com

Global MEMS Pressure Sensor Dies and ICs market size and forecasts, in consumption value ($ Million), sales quantity (Million Units), and average selling prices (US$/Unit), 2021-2032

Global MEMS Pressure Sensor Dies and ICs market size and forecasts by region and country, in consumption value ($ Million), sales quantity (Million Units), and average selling prices (US$/Unit), 2021-2032

Global MEMS Pressure Sensor Dies and ICs market size and forecasts, by Type and by Application, in consumption value ($ Million), sales quantity (Million Units), and average selling prices (US$/Unit), 2021-2032

Global MEMS Pressure Sensor Dies and ICs market shares of main players, shipments in revenue ($ Million), sales quantity (Million Units), and ASP (US$/Unit), 2021-2026

The Primary Objectives in This Report Are:

To determine the size of the total market opportunity of global and key countries

To assess the growth potential for MEMS Pressure Sensor Dies and ICs

To forecast future growth in each product and end-use market

To assess competitive factors affecting the marketplace

This report profiles key players in the global MEMS Pressure Sensor Dies and ICs market based on the following parameters - company overview, sales quantity, revenue, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Robert Bosch GmbH, Honeywell International Inc., TE Connectivity plc, Amphenol Corporation, Infineon Technologies AG, STMicroelectronics N.V., TDK Corporation, Murata Manufacturing Co., Ltd., MinebeaMitsumi Inc., Sensata Technologies Holding plc, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

MEMS Pressure Sensor Dies and ICs market is split by Type and by Application. For

+357 96 030922
info@marketpublishers.com

the period 2021-2032, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value. This analysis can help you expand your business by targeting qualified niche markets.

Market Segmentation

Market segment by Type

Uncompensated Packaged Sensor

Analog Compensated Sensor IC

Digital Pressure Sensor IC

Application-specific Pressure IC

Other

Market segment by Sensing Principle

Piezoresistive

Capacitive

Resonant

Other MEMS Principles

Market segment by Pressure Reference

Absolute Pressure

Gauge Pressure

+357 96 030922
info@marketpublishers.com

Differential Pressure

Other

Market segment by Pressure Range

Ultra-low Pressure, ?1 kPa

Low Pressure, >1–100 kPa

Medium Pressure, >0.1–1 MPa

High Pressure, >1 MPa

Market segment by Application

Barometric and Altitude Sensing

Differential Pressure and Flow Sensing

Liquid and Process Pressure Sensing

Respiratory and Physiological Pressure Sensing

Other

Major players covered

Robert Bosch GmbH

Honeywell International Inc.

TE Connectivity plc

Amphenol Corporation

+357 96 030922
info@marketpublishers.com

Infineon Technologies AG

STMicroelectronics N.V.

TDK Corporation

Murata Manufacturing Co., Ltd.

MinebeaMitsumi Inc.

Sensata Technologies Holding plc

OMRON Corporation

Alps Alpine Co., Ltd.

ROHM Co., Ltd.

Fujikura Ltd.

Melexis NV

Sensirion Holding AG

Merit Medical Systems, Inc.

Goertek Inc.

Bourns, Inc.

ScioSense B.V.

NOVOSENSE Microelectronics

MEMSensing Microsystems (Suzhou, China) Co., Ltd.

QST Corporation Limited

+357 96 030922
info@marketpublishers.com

Shenzhen Ampron Technology Co., Ltd.

Angst+Pfister Group

BCM SENSOR TECHNOLOGIES bv

ES Systems S.A.

Siargo Ltd.

Shenzhen MFrontier Electronics Co., Ltd.

Jintianhong Technology (Beijing) Co., Ltd.

Hunan Chntek Sensor Technology Co., Ltd.

Market segment by region, regional analysis covers

North America (United States, Canada, and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

Chapter Outline

Chapter 1, to describe MEMS Pressure Sensor Dies and ICs product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of MEMS Pressure Sensor Dies and ICs, with price, sales quantity, revenue, and global market share of MEMS Pressure Sensor

+357 96 030922
info@marketpublishers.com

Dies and ICs from 2021 to 2026.

Chapter 3, the MEMS Pressure Sensor Dies and ICs competitive situation, sales quantity, revenue, and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the MEMS Pressure Sensor Dies and ICs breakdown data are shown at the regional level, to show the sales quantity, consumption value, and growth by regions, from 2021 to 2032.

Chapter 5 and 6, to segment the sales by Type and by Application, with sales market share and growth rate by Type, by Application, from 2021 to 2032.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value, and market share for key countries in the world, from 2021 to 2026.and MEMS Pressure Sensor Dies and ICs market forecast, by regions, by Type, and by Application, with sales and revenue, from 2027 to 2032.

Chapter 12, market dynamics, drivers, restraints, trends, and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of MEMS Pressure Sensor Dies and ICs.

Chapter 14 and 15, to describe MEMS Pressure Sensor Dies and ICs sales channel, distributors, customers, research findings and conclusion.

+357 96 030922
info@marketpublishers.com

Contents

1 MARKET OVERVIEW

1.1 Product Overview and Scope
1.2 Market Estimation Caveats and Base Year
1.3 Market Analysis by Type
  1.3.1 Overview: Global MEMS Pressure Sensor Dies and ICs Consumption Value by Type: 2021 Versus 2025 Versus 2032
  1.3.2 Uncompensated Packaged Sensor
  1.3.3 Analog Compensated Sensor IC
  1.3.4 Digital Pressure Sensor IC
  1.3.5 Application-specific Pressure IC
  1.3.6 Other
1.4 Market Analysis by Sensing Principle
  1.4.1 Overview: Global MEMS Pressure Sensor Dies and ICs Consumption Value by Sensing Principle: 2021 Versus 2025 Versus 2032
  1.4.2 Piezoresistive
  1.4.3 Capacitive
  1.4.4 Resonant
  1.4.5 Other MEMS Principles
1.5 Market Analysis by Pressure Reference
  1.5.1 Overview: Global MEMS Pressure Sensor Dies and ICs Consumption Value by Pressure Reference: 2021 Versus 2025 Versus 2032
  1.5.2 Absolute Pressure
  1.5.3 Gauge Pressure
  1.5.4 Differential Pressure
  1.5.5 Other
1.6 Market Analysis by Pressure Range
  1.6.1 Overview: Global MEMS Pressure Sensor Dies and ICs Consumption Value by Pressure Range: 2021 Versus 2025 Versus 2032
  1.6.2 Ultra-low Pressure, ?1 kPa
  1.6.3 Low Pressure, >1–100 kPa
  1.6.4 Medium Pressure, >0.1–1 MPa
  1.6.5 High Pressure, >1 MPa
1.7 Market Analysis by Application
  1.7.1 Overview: Global MEMS Pressure Sensor Dies and ICs Consumption Value by Application: 2021 Versus 2025 Versus 2032
  1.7.2 Barometric and Altitude Sensing

+357 96 030922
info@marketpublishers.com

1.7.3 Differential Pressure and Flow Sensing
1.7.4 Liquid and Process Pressure Sensing
1.7.5 Respiratory and Physiological Pressure Sensing
1.7.6 Other
1.8 Global MEMS Pressure Sensor Dies and ICs Market Size & Forecast
1.8.1 Global MEMS Pressure Sensor Dies and ICs Consumption Value (2021 & 2025 & 2032)
1.8.2 Global MEMS Pressure Sensor Dies and ICs Sales Quantity (2021-2032)
1.8.3 Global MEMS Pressure Sensor Dies and ICs Average Price (2021-2032)

2 MANUFACTURERS PROFILES

2.1 Robert Bosch GmbH
2.1.1 Robert Bosch GmbH Details
2.1.2 Robert Bosch GmbH Major Business
2.1.3 Robert Bosch GmbH MEMS Pressure Sensor Dies and ICs Product and Services
2.1.4 Robert Bosch GmbH MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.1.5 Robert Bosch GmbH Recent Developments/Updates
2.2 Honeywell International Inc.
2.2.1 Honeywell International Inc. Details
2.2.2 Honeywell International Inc. Major Business
2.2.3 Honeywell International Inc. MEMS Pressure Sensor Dies and ICs Product and Services
2.2.4 Honeywell International Inc. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.2.5 Honeywell International Inc. Recent Developments/Updates
2.3 TE Connectivity plc
2.3.1 TE Connectivity plc Details
2.3.2 TE Connectivity plc Major Business
2.3.3 TE Connectivity plc MEMS Pressure Sensor Dies and ICs Product and Services
2.3.4 TE Connectivity plc MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.3.5 TE Connectivity plc Recent Developments/Updates
2.4 Amphenol Corporation
2.4.1 Amphenol Corporation Details
2.4.2 Amphenol Corporation Major Business
2.4.3 Amphenol Corporation MEMS Pressure Sensor Dies and ICs Product and

+357 96 030922
info@marketpublishers.com

Services
2.4.4 Amphenol Corporation MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.4.5 Amphenol Corporation Recent Developments/Updates
2.5 Infineon Technologies AG
2.5.1 Infineon Technologies AG Details
2.5.2 Infineon Technologies AG Major Business
2.5.3 Infineon Technologies AG MEMS Pressure Sensor Dies and ICs Product and Services
2.5.4 Infineon Technologies AG MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.5.5 Infineon Technologies AG Recent Developments/Updates
2.6 STMicroelectronics N.V.
2.6.1 STMicroelectronics N.V. Details
2.6.2 STMicroelectronics N.V. Major Business
2.6.3 STMicroelectronics N.V. MEMS Pressure Sensor Dies and ICs Product and Services
2.6.4 STMicroelectronics N.V. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.6.5 STMicroelectronics N.V. Recent Developments/Updates
2.7 TDK Corporation
2.7.1 TDK Corporation Details
2.7.2 TDK Corporation Major Business
2.7.3 TDK Corporation MEMS Pressure Sensor Dies and ICs Product and Services
2.7.4 TDK Corporation MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.7.5 TDK Corporation Recent Developments/Updates
2.8 Murata Manufacturing Co., Ltd.
2.8.1 Murata Manufacturing Co., Ltd. Details
2.8.2 Murata Manufacturing Co., Ltd. Major Business
2.8.3 Murata Manufacturing Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
2.8.4 Murata Manufacturing Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.8.5 Murata Manufacturing Co., Ltd. Recent Developments/Updates
2.9 MinebeaMitsumi Inc.
2.9.1 MinebeaMitsumi Inc. Details
2.9.2 MinebeaMitsumi Inc. Major Business
2.9.3 MinebeaMitsumi Inc. MEMS Pressure Sensor Dies and ICs Product and

+357 96 030922
info@marketpublishers.com

Services
2.9.4 MinebeaMitsumi Inc. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.9.5 MinebeaMitsumi Inc. Recent Developments/Updates
2.10 Sensata Technologies Holding plc
2.10.1 Sensata Technologies Holding plc Details
2.10.2 Sensata Technologies Holding plc Major Business
2.10.3 Sensata Technologies Holding plc MEMS Pressure Sensor Dies and ICs Product and Services
2.10.4 Sensata Technologies Holding plc MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.10.5 Sensata Technologies Holding plc Recent Developments/Updates
2.11 OMRON Corporation
2.11.1 OMRON Corporation Details
2.11.2 OMRON Corporation Major Business
2.11.3 OMRON Corporation MEMS Pressure Sensor Dies and ICs Product and Services
2.11.4 OMRON Corporation MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.11.5 OMRON Corporation Recent Developments/Updates
2.12 Alps Alpine Co., Ltd.
2.12.1 Alps Alpine Co., Ltd. Details
2.12.2 Alps Alpine Co., Ltd. Major Business
2.12.3 Alps Alpine Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
2.12.4 Alps Alpine Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.12.5 Alps Alpine Co., Ltd. Recent Developments/Updates
2.13 ROHM Co., Ltd.
2.13.1 ROHM Co., Ltd. Details
2.13.2 ROHM Co., Ltd. Major Business
2.13.3 ROHM Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
2.13.4 ROHM Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.13.5 ROHM Co., Ltd. Recent Developments/Updates
2.14 Fujikura Ltd.
2.14.1 Fujikura Ltd. Details
2.14.2 Fujikura Ltd. Major Business
2.14.3 Fujikura Ltd. MEMS Pressure Sensor Dies and ICs Product and Services

+357 96 030922
info@marketpublishers.com

2.14.4 Fujikura Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.14.5 Fujikura Ltd. Recent Developments/Updates
2.15 Melexis NV
2.15.1 Melexis NV Details
2.15.2 Melexis NV Major Business
2.15.3 Melexis NV MEMS Pressure Sensor Dies and ICs Product and Services
2.15.4 Melexis NV MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.15.5 Melexis NV Recent Developments/Updates
2.16 Sensirion Holding AG
2.16.1 Sensirion Holding AG Details
2.16.2 Sensirion Holding AG Major Business
2.16.3 Sensirion Holding AG MEMS Pressure Sensor Dies and ICs Product and Services
2.16.4 Sensirion Holding AG MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.16.5 Sensirion Holding AG Recent Developments/Updates
2.17 Merit Medical Systems, Inc.
2.17.1 Merit Medical Systems, Inc. Details
2.17.2 Merit Medical Systems, Inc. Major Business
2.17.3 Merit Medical Systems, Inc. MEMS Pressure Sensor Dies and ICs Product and Services
2.17.4 Merit Medical Systems, Inc. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.17.5 Merit Medical Systems, Inc. Recent Developments/Updates
2.18 Goertek Inc.
2.18.1 Goertek Inc. Details
2.18.2 Goertek Inc. Major Business
2.18.3 Goertek Inc. MEMS Pressure Sensor Dies and ICs Product and Services
2.18.4 Goertek Inc. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.18.5 Goertek Inc. Recent Developments/Updates
2.19 Bourns, Inc.
2.19.1 Bourns, Inc. Details
2.19.2 Bourns, Inc. Major Business
2.19.3 Bourns, Inc. MEMS Pressure Sensor Dies and ICs Product and Services
2.19.4 Bourns, Inc. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

+357 96 030922
info@marketpublishers.com

2.19.5 Bourns, Inc. Recent Developments/Updates
2.20 ScioSense B.V.
2.20.1 ScioSense B.V. Details
2.20.2 ScioSense B.V. Major Business
2.20.3 ScioSense B.V. MEMS Pressure Sensor Dies and ICs Product and Services
2.20.4 ScioSense B.V. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.20.5 ScioSense B.V. Recent Developments/Updates
2.21 NOVOSENSE Microelectronics
2.21.1 NOVOSENSE Microelectronics Details
2.21.2 NOVOSENSE Microelectronics Major Business
2.21.3 NOVOSENSE Microelectronics MEMS Pressure Sensor Dies and ICs Product and Services
2.21.4 NOVOSENSE Microelectronics MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.21.5 NOVOSENSE Microelectronics Recent Developments/Updates
2.22 MEMSensing Microsystems (Suzhou, China) Co., Ltd.
2.22.1 MEMSensing Microsystems (Suzhou, China) Co., Ltd. Details
2.22.2 MEMSensing Microsystems (Suzhou, China) Co., Ltd. Major Business
2.22.3 MEMSensing Microsystems (Suzhou, China) Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
2.22.4 MEMSensing Microsystems (Suzhou, China) Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.22.5 MEMSensing Microsystems (Suzhou, China) Co., Ltd. Recent Developments/Updates
2.23 QST Corporation Limited
2.23.1 QST Corporation Limited Details
2.23.2 QST Corporation Limited Major Business
2.23.3 QST Corporation Limited MEMS Pressure Sensor Dies and ICs Product and Services
2.23.4 QST Corporation Limited MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.23.5 QST Corporation Limited Recent Developments/Updates
2.24 Shenzhen Ampron Technology Co., Ltd.
2.24.1 Shenzhen Ampron Technology Co., Ltd. Details
2.24.2 Shenzhen Ampron Technology Co., Ltd. Major Business
2.24.3 Shenzhen Ampron Technology Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services

+357 96 030922
info@marketpublishers.com

2.24.4 Shenzhen Ampron Technology Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.24.5 Shenzhen Ampron Technology Co., Ltd. Recent Developments/Updates
2.25 Angst+Pfister Group
2.25.1 Angst+Pfister Group Details
2.25.2 Angst+Pfister Group Major Business
2.25.3 Angst+Pfister Group MEMS Pressure Sensor Dies and ICs Product and Services
2.25.4 Angst+Pfister Group MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.25.5 Angst+Pfister Group Recent Developments/Updates
2.26 BCM SENSOR TECHNOLOGIES bv
2.26.1 BCM SENSOR TECHNOLOGIES bv Details
2.26.2 BCM SENSOR TECHNOLOGIES bv Major Business
2.26.3 BCM SENSOR TECHNOLOGIES bv MEMS Pressure Sensor Dies and ICs Product and Services
2.26.4 BCM SENSOR TECHNOLOGIES bv MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.26.5 BCM SENSOR TECHNOLOGIES bv Recent Developments/Updates
2.27 ES Systems S.A.
2.27.1 ES Systems S.A. Details
2.27.2 ES Systems S.A. Major Business
2.27.3 ES Systems S.A. MEMS Pressure Sensor Dies and ICs Product and Services
2.27.4 ES Systems S.A. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.27.5 ES Systems S.A. Recent Developments/Updates
2.28 Siargo Ltd.
2.28.1 Siargo Ltd. Details
2.28.2 Siargo Ltd. Major Business
2.28.3 Siargo Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
2.28.4 Siargo Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.28.5 Siargo Ltd. Recent Developments/Updates
2.29 Shenzhen MFrontier Electronics Co., Ltd.
2.29.1 Shenzhen MFrontier Electronics Co., Ltd. Details
2.29.2 Shenzhen MFrontier Electronics Co., Ltd. Major Business
2.29.3 Shenzhen MFrontier Electronics Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
2.29.4 Shenzhen MFrontier Electronics Co., Ltd. MEMS Pressure Sensor Dies and ICs

+357 96 030922
info@marketpublishers.com

Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.29.5 Shenzhen MFrontier Electronics Co., Ltd. Recent Developments/Updates
2.30 Jintianhong Technology (Beijing) Co., Ltd.
2.30.1 Jintianhong Technology (Beijing) Co., Ltd. Details
2.30.2 Jintianhong Technology (Beijing) Co., Ltd. Major Business
2.30.3 Jintianhong Technology (Beijing) Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
2.30.4 Jintianhong Technology (Beijing) Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.30.5 Jintianhong Technology (Beijing) Co., Ltd. Recent Developments/Updates
2.31 Hunan Chntek Sensor Technology Co., Ltd.
2.31.1 Hunan Chntek Sensor Technology Co., Ltd. Details
2.31.2 Hunan Chntek Sensor Technology Co., Ltd. Major Business
2.31.3 Hunan Chntek Sensor Technology Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
2.31.4 Hunan Chntek Sensor Technology Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)
2.31.5 Hunan Chntek Sensor Technology Co., Ltd. Recent Developments/Updates

3 COMPETITIVE ENVIRONMENT: MEMS PRESSURE SENSOR DIES AND ICS BY MANUFACTURER

3.1 Global MEMS Pressure Sensor Dies and ICs Sales Quantity by Manufacturer (2021-2026)
3.2 Global MEMS Pressure Sensor Dies and ICs Revenue by Manufacturer (2021-2026)
3.3 Global MEMS Pressure Sensor Dies and ICs Average Price by Manufacturer (2021-2026)
3.4 Market Share Analysis (2025)
3.4.1 Producer Shipments of MEMS Pressure Sensor Dies and ICs by Manufacturer Revenue ($MM) and Market Share (%): 2025
3.4.2 Top 3 MEMS Pressure Sensor Dies and ICs Manufacturer Market Share in 2025
3.4.3 Top 6 MEMS Pressure Sensor Dies and ICs Manufacturer Market Share in 2025
3.5 MEMS Pressure Sensor Dies and ICs Market: Overall Company Footprint Analysis
3.5.1 MEMS Pressure Sensor Dies and ICs Market: Region Footprint
3.5.2 MEMS Pressure Sensor Dies and ICs Market: Company Product Type Footprint
3.5.3 MEMS Pressure Sensor Dies and ICs Market: Company Product Application

+357 96 030922
info@marketpublishers.com

Footprint
3.6 New Market Entrants and Barriers to Market Entry
3.7 Mergers, Acquisition, Agreements, and Collaborations

4 CONSUMPTION ANALYSIS BY REGION

4.1 Global MEMS Pressure Sensor Dies and ICs Market Size by Region
  4.1.1 Global MEMS Pressure Sensor Dies and ICs Sales Quantity by Region (2021-2032)
  4.1.2 Global MEMS Pressure Sensor Dies and ICs Consumption Value by Region (2021-2032)
  4.1.3 Global MEMS Pressure Sensor Dies and ICs Average Price by Region (2021-2032)
4.2 North America MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032)
4.3 Europe MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032)
4.4 Asia-Pacific MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032)
4.5 South America MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032)
4.6 Middle East & Africa MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032)

5 MARKET SEGMENT BY TYPE

5.1 Global MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2032)
5.2 Global MEMS Pressure Sensor Dies and ICs Consumption Value by Type (2021-2032)
5.3 Global MEMS Pressure Sensor Dies and ICs Average Price by Type (2021-2032)

6 MARKET SEGMENT BY APPLICATION

6.1 Global MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2032)
6.2 Global MEMS Pressure Sensor Dies and ICs Consumption Value by Application (2021-2032)
6.3 Global MEMS Pressure Sensor Dies and ICs Average Price by Application (2021-2032)

7 NORTH AMERICA

+357 96 030922
info@marketpublishers.com

7.1 North America MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2032)
7.2 North America MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2032)
7.3 North America MEMS Pressure Sensor Dies and ICs Market Size by Country
7.3.1 North America MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2021-2032)
7.3.2 North America MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2021-2032)
7.3.3 United States Market Size and Forecast (2021-2032)
7.3.4 Canada Market Size and Forecast (2021-2032)
7.3.5 Mexico Market Size and Forecast (2021-2032)

8 EUROPE

8.1 Europe MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2032)
8.2 Europe MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2032)
8.3 Europe MEMS Pressure Sensor Dies and ICs Market Size by Country
8.3.1 Europe MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2021-2032)
8.3.2 Europe MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2021-2032)
8.3.3 Germany Market Size and Forecast (2021-2032)
8.3.4 France Market Size and Forecast (2021-2032)
8.3.5 United Kingdom Market Size and Forecast (2021-2032)
8.3.6 Russia Market Size and Forecast (2021-2032)
8.3.7 Italy Market Size and Forecast (2021-2032)

9 ASIA-PACIFIC

9.1 Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2032)
9.2 Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2032)
9.3 Asia-Pacific MEMS Pressure Sensor Dies and ICs Market Size by Region
9.3.1 Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity by Region (2021-2032)

+357 96 030922
info@marketpublishers.com

9.3.2 Asia-Pacific MEMS Pressure Sensor Dies and ICs Consumption Value by Region (2021-2032)
9.3.3 China Market Size and Forecast (2021-2032)
9.3.4 Japan Market Size and Forecast (2021-2032)
9.3.5 South Korea Market Size and Forecast (2021-2032)
9.3.6 India Market Size and Forecast (2021-2032)
9.3.7 Southeast Asia Market Size and Forecast (2021-2032)
9.3.8 Australia Market Size and Forecast (2021-2032)

10 SOUTH AMERICA

10.1 South America MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2032)
10.2 South America MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2032)
10.3 South America MEMS Pressure Sensor Dies and ICs Market Size by Country
10.3.1 South America MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2021-2032)
10.3.2 South America MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2021-2032)
10.3.3 Brazil Market Size and Forecast (2021-2032)
10.3.4 Argentina Market Size and Forecast (2021-2032)

11 MIDDLE EAST & AFRICA

11.1 Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2032)
11.2 Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2032)
11.3 Middle East & Africa MEMS Pressure Sensor Dies and ICs Market Size by Country
11.3.1 Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2021-2032)
11.3.2 Middle East & Africa MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2021-2032)
11.3.3 Turkey Market Size and Forecast (2021-2032)
11.3.4 Egypt Market Size and Forecast (2021-2032)
11.3.5 Saudi Arabia Market Size and Forecast (2021-2032)
11.3.6 South Africa Market Size and Forecast (2021-2032)

+357 96 030922
info@marketpublishers.com

12 MARKET DYNAMICS

12.1 MEMS Pressure Sensor Dies and ICs Market Drivers
12.2 MEMS Pressure Sensor Dies and ICs Market Restraints
12.3 MEMS Pressure Sensor Dies and ICs Trends Analysis
12.4 Porters Five Forces Analysis
  12.4.1 Threat of New Entrants
  12.4.2 Bargaining Power of Suppliers
  12.4.3 Bargaining Power of Buyers
  12.4.4 Threat of Substitutes
  12.4.5 Competitive Rivalry

13 RAW MATERIAL AND INDUSTRY CHAIN

13.1 Raw Material of MEMS Pressure Sensor Dies and ICs and Key Manufacturers
13.2 Manufacturing Costs Percentage of MEMS Pressure Sensor Dies and ICs
13.3 MEMS Pressure Sensor Dies and ICs Production Process
13.4 Industry Value Chain Analysis

14 SHIPMENTS BY DISTRIBUTION CHANNEL

14.1 Sales Channel
  14.1.1 Direct to End-User
  14.1.2 Distributors
14.2 MEMS Pressure Sensor Dies and ICs Typical Distributors
14.3 MEMS Pressure Sensor Dies and ICs Typical Customers

15 RESEARCH FINDINGS AND CONCLUSION

16 APPENDIX

16.1 Methodology
16.2 Research Process and Data Source
16.3 Disclaimer

+357 96 030922
info@marketpublishers.com

List Of Tables

LIST OF TABLES

Table 1. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Type, (USD Million), 2021 & 2025 & 2032
Table 2. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Sensing Principle, (USD Million), 2021 & 2025 & 2032
Table 3. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Pressure Reference, (USD Million), 2021 & 2025 & 2032
Table 4. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Pressure Range, (USD Million), 2021 & 2025 & 2032
Table 5. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Application, (USD Million), 2021 & 2025 & 2032
Table 6. Robert Bosch GmbH Basic Information, Manufacturing Base and Competitors
Table 7. Robert Bosch GmbH Major Business
Table 8. Robert Bosch GmbH MEMS Pressure Sensor Dies and ICs Product and Services
Table 9. Robert Bosch GmbH MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 10. Robert Bosch GmbH Recent Developments/Updates
Table 11. Honeywell International Inc. Basic Information, Manufacturing Base and Competitors
Table 12. Honeywell International Inc. Major Business
Table 13. Honeywell International Inc. MEMS Pressure Sensor Dies and ICs Product and Services
Table 14. Honeywell International Inc. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 15. Honeywell International Inc. Recent Developments/Updates
Table 16. TE Connectivity plc Basic Information, Manufacturing Base and Competitors
Table 17. TE Connectivity plc Major Business
Table 18. TE Connectivity plc MEMS Pressure Sensor Dies and ICs Product and Services
Table 19. TE Connectivity plc MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 20. TE Connectivity plc Recent Developments/Updates

+357 96 030922
info@marketpublishers.com

Table 21. Amphenol Corporation Basic Information, Manufacturing Base and Competitors
Table 22. Amphenol Corporation Major Business
Table 23. Amphenol Corporation MEMS Pressure Sensor Dies and ICs Product and Services
Table 24. Amphenol Corporation MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 25. Amphenol Corporation Recent Developments/Updates
Table 26. Infineon Technologies AG Basic Information, Manufacturing Base and Competitors
Table 27. Infineon Technologies AG Major Business
Table 28. Infineon Technologies AG MEMS Pressure Sensor Dies and ICs Product and Services
Table 29. Infineon Technologies AG MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 30. Infineon Technologies AG Recent Developments/Updates
Table 31. STMicroelectronics N.V. Basic Information, Manufacturing Base and Competitors
Table 32. STMicroelectronics N.V. Major Business
Table 33. STMicroelectronics N.V. MEMS Pressure Sensor Dies and ICs Product and Services
Table 34. STMicroelectronics N.V. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 35. STMicroelectronics N.V. Recent Developments/Updates
Table 36. TDK Corporation Basic Information, Manufacturing Base and Competitors
Table 37. TDK Corporation Major Business
Table 38. TDK Corporation MEMS Pressure Sensor Dies and ICs Product and Services
Table 39. TDK Corporation MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 40. TDK Corporation Recent Developments/Updates
Table 41. Murata Manufacturing Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 42. Murata Manufacturing Co., Ltd. Major Business
Table 43. Murata Manufacturing Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services

+357 96 030922
info@marketpublishers.com

Table 44. Murata Manufacturing Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 45. Murata Manufacturing Co., Ltd. Recent Developments/Updates
Table 46. MinebeaMitsumi Inc. Basic Information, Manufacturing Base and Competitors
Table 47. MinebeaMitsumi Inc. Major Business
Table 48. MinebeaMitsumi Inc. MEMS Pressure Sensor Dies and ICs Product and Services
Table 49. MinebeaMitsumi Inc. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 50. MinebeaMitsumi Inc. Recent Developments/Updates
Table 51. Sensata Technologies Holding plc Basic Information, Manufacturing Base and Competitors
Table 52. Sensata Technologies Holding plc Major Business
Table 53. Sensata Technologies Holding plc MEMS Pressure Sensor Dies and ICs Product and Services
Table 54. Sensata Technologies Holding plc MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 55. Sensata Technologies Holding plc Recent Developments/Updates
Table 56. OMRON Corporation Basic Information, Manufacturing Base and Competitors
Table 57. OMRON Corporation Major Business
Table 58. OMRON Corporation MEMS Pressure Sensor Dies and ICs Product and Services
Table 59. OMRON Corporation MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 60. OMRON Corporation Recent Developments/Updates
Table 61. Alps Alpine Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 62. Alps Alpine Co., Ltd. Major Business
Table 63. Alps Alpine Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
Table 64. Alps Alpine Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 65. Alps Alpine Co., Ltd. Recent Developments/Updates
Table 66. ROHM Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 67. ROHM Co., Ltd. Major Business

+357 96 030922
info@marketpublishers.com

Table 68. ROHM Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
Table 69. ROHM Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 70. ROHM Co., Ltd. Recent Developments/Updates
Table 71. Fujikura Ltd. Basic Information, Manufacturing Base and Competitors
Table 72. Fujikura Ltd. Major Business
Table 73. Fujikura Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
Table 74. Fujikura Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 75. Fujikura Ltd. Recent Developments/Updates
Table 76. Melexis NV Basic Information, Manufacturing Base and Competitors
Table 77. Melexis NV Major Business
Table 78. Melexis NV MEMS Pressure Sensor Dies and ICs Product and Services
Table 79. Melexis NV MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 80. Melexis NV Recent Developments/Updates
Table 81. Sensirion Holding AG Basic Information, Manufacturing Base and Competitors
Table 82. Sensirion Holding AG Major Business
Table 83. Sensirion Holding AG MEMS Pressure Sensor Dies and ICs Product and Services
Table 84. Sensirion Holding AG MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 85. Sensirion Holding AG Recent Developments/Updates
Table 86. Merit Medical Systems, Inc. Basic Information, Manufacturing Base and Competitors
Table 87. Merit Medical Systems, Inc. Major Business
Table 88. Merit Medical Systems, Inc. MEMS Pressure Sensor Dies and ICs Product and Services
Table 89. Merit Medical Systems, Inc. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 90. Merit Medical Systems, Inc. Recent Developments/Updates
Table 91. Goertek Inc. Basic Information, Manufacturing Base and Competitors
Table 92. Goertek Inc. Major Business

+357 96 030922
info@marketpublishers.com

Table 93. Goertek Inc. MEMS Pressure Sensor Dies and ICs Product and Services
Table 94. Goertek Inc. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 95. Goertek Inc. Recent Developments/Updates
Table 96. Bourns, Inc. Basic Information, Manufacturing Base and Competitors
Table 97. Bourns, Inc. Major Business
Table 98. Bourns, Inc. MEMS Pressure Sensor Dies and ICs Product and Services
Table 99. Bourns, Inc. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 100. Bourns, Inc. Recent Developments/Updates
Table 101. ScioSense B.V. Basic Information, Manufacturing Base and Competitors
Table 102. ScioSense B.V. Major Business
Table 103. ScioSense B.V. MEMS Pressure Sensor Dies and ICs Product and Services
Table 104. ScioSense B.V. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 105. ScioSense B.V. Recent Developments/Updates
Table 106. NOVOSENSE Microelectronics Basic Information, Manufacturing Base and Competitors
Table 107. NOVOSENSE Microelectronics Major Business
Table 108. NOVOSENSE Microelectronics MEMS Pressure Sensor Dies and ICs Product and Services
Table 109. NOVOSENSE Microelectronics MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 110. NOVOSENSE Microelectronics Recent Developments/Updates
Table 111. MEMSensing Microsystems (Suzhou, China) Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 112. MEMSensing Microsystems (Suzhou, China) Co., Ltd. Major Business
Table 113. MEMSensing Microsystems (Suzhou, China) Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
Table 114. MEMSensing Microsystems (Suzhou, China) Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 115. MEMSensing Microsystems (Suzhou, China) Co., Ltd. Recent Developments/Updates
Table 116. QST Corporation Limited Basic Information, Manufacturing Base and

+357 96 030922
info@marketpublishers.com

Competitors
Table 117. QST Corporation Limited Major Business
Table 118. QST Corporation Limited MEMS Pressure Sensor Dies and ICs Product and Services
Table 119. QST Corporation Limited MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 120. QST Corporation Limited Recent Developments/Updates
Table 121. Shenzhen Ampron Technology Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 122. Shenzhen Ampron Technology Co., Ltd. Major Business
Table 123. Shenzhen Ampron Technology Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
Table 124. Shenzhen Ampron Technology Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 125. Shenzhen Ampron Technology Co., Ltd. Recent Developments/Updates
Table 126. Angst+Pfister Group Basic Information, Manufacturing Base and Competitors
Table 127. Angst+Pfister Group Major Business
Table 128. Angst+Pfister Group MEMS Pressure Sensor Dies and ICs Product and Services
Table 129. Angst+Pfister Group MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 130. Angst+Pfister Group Recent Developments/Updates
Table 131. BCM SENSOR TECHNOLOGIES bv Basic Information, Manufacturing Base and Competitors
Table 132. BCM SENSOR TECHNOLOGIES bv Major Business
Table 133. BCM SENSOR TECHNOLOGIES bv MEMS Pressure Sensor Dies and ICs Product and Services
Table 134. BCM SENSOR TECHNOLOGIES bv MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 135. BCM SENSOR TECHNOLOGIES bv Recent Developments/Updates
Table 136. ES Systems S.A. Basic Information, Manufacturing Base and Competitors
Table 137. ES Systems S.A. Major Business
Table 138. ES Systems S.A. MEMS Pressure Sensor Dies and ICs Product and Services

+357 96 030922
info@marketpublishers.com

Table 139. ES Systems S.A. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 140. ES Systems S.A. Recent Developments/Updates
Table 141. Siargo Ltd. Basic Information, Manufacturing Base and Competitors
Table 142. Siargo Ltd. Major Business
Table 143. Siargo Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
Table 144. Siargo Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 145. Siargo Ltd. Recent Developments/Updates
Table 146. Shenzhen MFrontier Electronics Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 147. Shenzhen MFrontier Electronics Co., Ltd. Major Business
Table 148. Shenzhen MFrontier Electronics Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
Table 149. Shenzhen MFrontier Electronics Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 150. Shenzhen MFrontier Electronics Co., Ltd. Recent Developments/Updates
Table 151. Jintianhong Technology (Beijing) Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 152. Jintianhong Technology (Beijing) Co., Ltd. Major Business
Table 153. Jintianhong Technology (Beijing) Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
Table 154. Jintianhong Technology (Beijing) Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 155. Jintianhong Technology (Beijing) Co., Ltd. Recent Developments/Updates
Table 156. Hunan Chntek Sensor Technology Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 157. Hunan Chntek Sensor Technology Co., Ltd. Major Business
Table 158. Hunan Chntek Sensor Technology Co., Ltd. MEMS Pressure Sensor Dies and ICs Product and Services
Table 159. Hunan Chntek Sensor Technology Co., Ltd. MEMS Pressure Sensor Dies and ICs Sales Quantity (Million Units), Average Price (US$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)
Table 160. Hunan Chntek Sensor Technology Co., Ltd. Recent Developments/Updates
Table 161. Global MEMS Pressure Sensor Dies and ICs Sales Quantity by

+357 96 030922
info@marketpublishers.com

Manufacturer (2021-2026) & (Million Units)
Table 162. Global MEMS Pressure Sensor Dies and ICs Revenue by Manufacturer (2021-2026) & (USD Million)
Table 163. Global MEMS Pressure Sensor Dies and ICs Average Price by Manufacturer (2021-2026) & (US$/Unit)
Table 164. Market Position of Manufacturers in MEMS Pressure Sensor Dies and ICs, (Tier 1, Tier 2, and Tier 3), Based on Revenue in 2025
Table 165. Head Office and MEMS Pressure Sensor Dies and ICs Production Site of Key Manufacturer
Table 166. MEMS Pressure Sensor Dies and ICs Market: Company Product Type Footprint
Table 167. MEMS Pressure Sensor Dies and ICs Market: Company Product Application Footprint
Table 168. MEMS Pressure Sensor Dies and ICs New Market Entrants and Barriers to Market Entry
Table 169. MEMS Pressure Sensor Dies and ICs Mergers, Acquisition, Agreements, and Collaborations
Table 170. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Region (2021-2025-2032) & (USD Million) & CAGR
Table 171. Global MEMS Pressure Sensor Dies and ICs Sales Quantity by Region (2021-2026) & (Million Units)
Table 172. Global MEMS Pressure Sensor Dies and ICs Sales Quantity by Region (2027-2032) & (Million Units)
Table 173. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Region (2021-2026) & (USD Million)
Table 174. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Region (2027-2032) & (USD Million)
Table 175. Global MEMS Pressure Sensor Dies and ICs Average Price by Region (2021-2026) & (US$/Unit)
Table 176. Global MEMS Pressure Sensor Dies and ICs Average Price by Region (2027-2032) & (US$/Unit)
Table 177. Global MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2026) & (Million Units)
Table 178. Global MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2027-2032) & (Million Units)
Table 179. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Type (2021-2026) & (USD Million)
Table 180. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Type (2027-2032) & (USD Million)

+357 96 030922
info@marketpublishers.com

Table 181. Global MEMS Pressure Sensor Dies and ICs Average Price by Type (2021-2026) & (US$/Unit)
Table 182. Global MEMS Pressure Sensor Dies and ICs Average Price by Type (2027-2032) & (US$/Unit)
Table 183. Global MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2026) & (Million Units)
Table 184. Global MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2027-2032) & (Million Units)
Table 185. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Application (2021-2026) & (USD Million)
Table 186. Global MEMS Pressure Sensor Dies and ICs Consumption Value by Application (2027-2032) & (USD Million)
Table 187. Global MEMS Pressure Sensor Dies and ICs Average Price by Application (2021-2026) & (US$/Unit)
Table 188. Global MEMS Pressure Sensor Dies and ICs Average Price by Application (2027-2032) & (US$/Unit)
Table 189. North America MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2026) & (Million Units)
Table 190. North America MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2027-2032) & (Million Units)
Table 191. North America MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2026) & (Million Units)
Table 192. North America MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2027-2032) & (Million Units)
Table 193. North America MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2021-2026) & (Million Units)
Table 194. North America MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2027-2032) & (Million Units)
Table 195. North America MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2021-2026) & (USD Million)
Table 196. North America MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2027-2032) & (USD Million)
Table 197. Europe MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2026) & (Million Units)
Table 198. Europe MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2027-2032) & (Million Units)
Table 199. Europe MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2026) & (Million Units)
Table 200. Europe MEMS Pressure Sensor Dies and ICs Sales Quantity by Application

+357 96 030922
info@marketpublishers.com

(2027-2032) & (Million Units)
Table 201. Europe MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2021-2026) & (Million Units)
Table 202. Europe MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2027-2032) & (Million Units)
Table 203. Europe MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2021-2026) & (USD Million)
Table 204. Europe MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2027-2032) & (USD Million)
Table 205. Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2026) & (Million Units)
Table 206. Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2027-2032) & (Million Units)
Table 207. Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2026) & (Million Units)
Table 208. Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2027-2032) & (Million Units)
Table 209. Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity by Region (2021-2026) & (Million Units)
Table 210. Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity by Region (2027-2032) & (Million Units)
Table 211. Asia-Pacific MEMS Pressure Sensor Dies and ICs Consumption Value by Region (2021-2026) & (USD Million)
Table 212. Asia-Pacific MEMS Pressure Sensor Dies and ICs Consumption Value by Region (2027-2032) & (USD Million)
Table 213. South America MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2026) & (Million Units)
Table 214. South America MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2027-2032) & (Million Units)
Table 215. South America MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2026) & (Million Units)
Table 216. South America MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2027-2032) & (Million Units)
Table 217. South America MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2021-2026) & (Million Units)
Table 218. South America MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2027-2032) & (Million Units)
Table 219. South America MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2021-2026) & (USD Million)

+357 96 030922
info@marketpublishers.com

Table 220. South America MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2027-2032) & (USD Million)
Table 221. Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2021-2026) & (Million Units)
Table 222. Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity by Type (2027-2032) & (Million Units)
Table 223. Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2021-2026) & (Million Units)
Table 224. Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity by Application (2027-2032) & (Million Units)
Table 225. Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2021-2026) & (Million Units)
Table 226. Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity by Country (2027-2032) & (Million Units)
Table 227. Middle East & Africa MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2021-2026) & (USD Million)
Table 228. Middle East & Africa MEMS Pressure Sensor Dies and ICs Consumption Value by Country (2027-2032) & (USD Million)
Table 229. MEMS Pressure Sensor Dies and ICs Raw Material
Table 230. Key Manufacturers of MEMS Pressure Sensor Dies and ICs Raw Materials
Table 231. MEMS Pressure Sensor Dies and ICs Typical Distributors
Table 232. MEMS Pressure Sensor Dies and ICs Typical Customers

+357 96 030922
info@marketpublishers.com

List Of Figures

LIST OF FIGURES

Figure 1. MEMS Pressure Sensor Dies and ICs Picture
Figure 2. Global MEMS Pressure Sensor Dies and ICs Revenue by Type, (USD Million), 2021 & 2025 & 2032
Figure 3. Global MEMS Pressure Sensor Dies and ICs Revenue Market Share by Type in 2025
Figure 4. Uncompensated Packaged Sensor Examples
Figure 5. Analog Compensated Sensor IC Examples
Figure 6. Digital Pressure Sensor IC Examples
Figure 7. Application-specific Pressure IC Examples
Figure 8. Other Examples
Figure 9. Global MEMS Pressure Sensor Dies and ICs Revenue by Sensing Principle, (USD Million), 2021 & 2025 & 2032
Figure 10. Global MEMS Pressure Sensor Dies and ICs Revenue Market Share by Sensing Principle in 2025
Figure 11. Piezoresistive Examples
Figure 12. Capacitive Examples
Figure 13. Resonant Examples
Figure 14. Other MEMS Principles Examples
Figure 15. Global MEMS Pressure Sensor Dies and ICs Revenue by Pressure Reference, (USD Million), 2021 & 2025 & 2032
Figure 16. Global MEMS Pressure Sensor Dies and ICs Revenue Market Share by Pressure Reference in 2025
Figure 17. Absolute Pressure Examples
Figure 18. Gauge Pressure Examples
Figure 19. Differential Pressure Examples
Figure 20. Other Examples
Figure 21. Global MEMS Pressure Sensor Dies and ICs Revenue by Pressure Range, (USD Million), 2021 & 2025 & 2032
Figure 22. Global MEMS Pressure Sensor Dies and ICs Revenue Market Share by Pressure Range in 2025
Figure 23. Ultra-low Pressure, ?1 kPa Examples
Figure 24. Low Pressure, >1–100 kPa Examples
Figure 25. Medium Pressure, >0.1–1 MPa Examples
Figure 26. High Pressure, >1 MPa Examples
Figure 27. Global MEMS Pressure Sensor Dies and ICs Consumption Value by

+357 96 030922
info@marketpublishers.com

Application, (USD Million), 2021 & 2025 & 2032
Figure 28. Global MEMS Pressure Sensor Dies and ICs Revenue Market Share by Application in 2025
Figure 29. Barometric and Altitude Sensing Examples
Figure 30. Differential Pressure and Flow Sensing Examples
Figure 31. Liquid and Process Pressure Sensing Examples
Figure 32. Respiratory and Physiological Pressure Sensing Examples
Figure 33. Other Examples
Figure 34. Global MEMS Pressure Sensor Dies and ICs Consumption Value, (USD Million): 2021 & 2025 & 2032
Figure 35. Global MEMS Pressure Sensor Dies and ICs Consumption Value and Forecast (2021-2032) & (USD Million)
Figure 36. Global MEMS Pressure Sensor Dies and ICs Sales Quantity (2021-2032) & (Million Units)
Figure 37. Global MEMS Pressure Sensor Dies and ICs Price (2021-2032) & (US$/Unit)
Figure 38. Global MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Manufacturer in 2025
Figure 39. Global MEMS Pressure Sensor Dies and ICs Revenue Market Share by Manufacturer in 2025
Figure 40. Producer Shipments of MEMS Pressure Sensor Dies and ICs by Manufacturer Sales ($MM) and Market Share (%): 2025
Figure 41. Top 3 MEMS Pressure Sensor Dies and ICs Manufacturer (Revenue) Market Share in 2025
Figure 42. Top 6 MEMS Pressure Sensor Dies and ICs Manufacturer (Revenue) Market Share in 2025
Figure 43. Global MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Region (2021-2032)
Figure 44. Global MEMS Pressure Sensor Dies and ICs Consumption Value Market Share by Region (2021-2032)
Figure 45. North America MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 46. Europe MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 47. Asia-Pacific MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 48. South America MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 49. Middle East & Africa MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)

+357 96 030922
info@marketpublishers.com

Figure 50. Global MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Type (2021-2032)
Figure 51. Global MEMS Pressure Sensor Dies and ICs Consumption Value Market Share by Type (2021-2032)
Figure 52. Global MEMS Pressure Sensor Dies and ICs Average Price by Type (2021-2032) & (US$/Unit)
Figure 53. Global MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Application (2021-2032)
Figure 54. Global MEMS Pressure Sensor Dies and ICs Revenue Market Share by Application (2021-2032)
Figure 55. Global MEMS Pressure Sensor Dies and ICs Average Price by Application (2021-2032) & (US$/Unit)
Figure 56. North America MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Type (2021-2032)
Figure 57. North America MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Application (2021-2032)
Figure 58. North America MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Country (2021-2032)
Figure 59. North America MEMS Pressure Sensor Dies and ICs Consumption Value Market Share by Country (2021-2032)
Figure 60. United States MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 61. Canada MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 62. Mexico MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 63. Europe MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Type (2021-2032)
Figure 64. Europe MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Application (2021-2032)
Figure 65. Europe MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Country (2021-2032)
Figure 66. Europe MEMS Pressure Sensor Dies and ICs Consumption Value Market Share by Country (2021-2032)
Figure 67. Germany MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 68. France MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 69. United Kingdom MEMS Pressure Sensor Dies and ICs Consumption Value

+357 96 030922
info@marketpublishers.com

(2021-2032) & (USD Million)
Figure 70. Russia MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 71. Italy MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 72. Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Type (2021-2032)
Figure 73. Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Application (2021-2032)
Figure 74. Asia-Pacific MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Region (2021-2032)
Figure 75. Asia-Pacific MEMS Pressure Sensor Dies and ICs Consumption Value Market Share by Region (2021-2032)
Figure 76. China MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 77. Japan MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 78. South Korea MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 79. India MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 80. Southeast Asia MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 81. Australia MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 82. South America MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Type (2021-2032)
Figure 83. South America MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Application (2021-2032)
Figure 84. South America MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Country (2021-2032)
Figure 85. South America MEMS Pressure Sensor Dies and ICs Consumption Value Market Share by Country (2021-2032)
Figure 86. Brazil MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 87. Argentina MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 88. Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Type (2021-2032)

+357 96 030922
info@marketpublishers.com

Figure 89. Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Application (2021-2032)
Figure 90. Middle East & Africa MEMS Pressure Sensor Dies and ICs Sales Quantity Market Share by Country (2021-2032)
Figure 91. Middle East & Africa MEMS Pressure Sensor Dies and ICs Consumption Value Market Share by Country (2021-2032)
Figure 92. Turkey MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 93. Egypt MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)
Figure 94. Saudi Arabia MEMS Pressure Sensor Dies and ICs Consumption Value (2021-2032) & (USD Million)

+357 96 030922
info@marketpublishers.com

I would like to order

Product name: Global MEMS Pressure Sensor Dies and ICs Market 2026 by Manufacturers, Regions, Type and Application, Forecast to 2032

Product link: https://marketpublishers.com/r/GEFF76077AA8EN.html

Price: US$ 3,480.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:
info@marketpublishers.com

Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page https://marketpublishers.com/r/GEFF76077AA8EN.html